Pressure sensors

Pressure transmitter with SPI output

Series/Type: AVR 0.016 KA D4 Z14E L ST B538
Ordering code: B58621V4121B538
Date: 2020-05-26
Version: 2
Applications

- Differential pressure measurement
- Gauge pressure measurement

Features

- Piezoresistive MEMS technology
- Measured media (Port A): Air, non-aggressive gases (gas humidity 0 ... 100% r.h.). Unsuitable for substances reacting with glass, silicon, gold, epoxy glue or silicone glue.
- Measured media (Port B): Air, non-aggressive gases (gas humidity 0 ... 85% r.h., without dew) Unsuitable for substances reacting with glass, silicon, gold, aluminum, nickel, epoxy glue, silicone glue or silicone gel.
- Digital SPI output proportional to pressure: 10 ... 90% of digital output range (14 bit)
- Integrated temperature measurement
- RoHS-compatible
- Alternative pressure ranges on request
- Alternative configuration of SPI output on request
- I²C output on request

Dimensional drawings

All dimensions in mm
## Technical data

### Absolute maximum ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Conditions</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Temperature ranges</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Storage temperature range</td>
<td>$T_{st}$</td>
<td>$^1$</td>
<td>–30</td>
<td>+70</td>
<td></td>
<td>°C</td>
</tr>
<tr>
<td>Operating temperature range</td>
<td>$T_a$</td>
<td>$^2$</td>
<td>–20</td>
<td>+70</td>
<td></td>
<td>°C</td>
</tr>
<tr>
<td>Compensated temperature range</td>
<td>$T_c$</td>
<td>$^3$</td>
<td>–20</td>
<td>+70</td>
<td></td>
<td>°C</td>
</tr>
<tr>
<td><strong>Pressure ranges</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Rated pressure range</td>
<td>$p_r$</td>
<td></td>
<td>0</td>
<td>16</td>
<td></td>
<td>mbar</td>
</tr>
<tr>
<td>Overpressure</td>
<td>$p_{ov}$</td>
<td></td>
<td>–160</td>
<td>160</td>
<td></td>
<td>mbar</td>
</tr>
<tr>
<td><strong>Supply voltage /-current</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Supply voltage</td>
<td>$V_{CC}$</td>
<td>$^6$</td>
<td>2.7</td>
<td>5.5</td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Supply current</td>
<td>$I_{CC}$</td>
<td></td>
<td>3</td>
<td>10</td>
<td></td>
<td>mA</td>
</tr>
</tbody>
</table>

### Output signal @ $T_a = 25$ °C, $V_{CC} = 5$ V

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Conditions</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Digital output range</td>
<td></td>
<td></td>
<td>0</td>
<td>16384</td>
<td></td>
<td>digit</td>
</tr>
<tr>
<td>Offset $^f$</td>
<td>$D_A0$</td>
<td>@ $25$ °C $^7$</td>
<td>1638</td>
<td></td>
<td></td>
<td>digit</td>
</tr>
<tr>
<td>Signal span (Full Scale)</td>
<td>$D_{FS}$</td>
<td>@ $25$ °C $^8$</td>
<td>13107</td>
<td></td>
<td></td>
<td>digit</td>
</tr>
<tr>
<td>Temperatur output range (-50…150°C)</td>
<td></td>
<td></td>
<td>0</td>
<td>2048</td>
<td></td>
<td>digit</td>
</tr>
<tr>
<td>Offset error</td>
<td>$E_{D LTS}$</td>
<td>@ $25$ °C $^9$</td>
<td>±1</td>
<td>±5</td>
<td>% FS</td>
<td></td>
</tr>
<tr>
<td>Nonlinearity</td>
<td>$L$</td>
<td>@ $25$ °C $^{10}$</td>
<td>±0.15</td>
<td>±0.5</td>
<td>% FS</td>
<td></td>
</tr>
<tr>
<td>Characteristic curve error</td>
<td>$E_c$</td>
<td>@ $T_a = –20$ …70 °C $^3$ $^{11}$</td>
<td>±0.5</td>
<td>±1.0</td>
<td>% FS</td>
<td></td>
</tr>
<tr>
<td>Total error ($E_{D LTS} + E_c$)</td>
<td>$E_{total}$</td>
<td>@ $T_a = –20$ …70 °C $^3$ $^{12}$</td>
<td>±1.5</td>
<td>±6.0</td>
<td>% FS</td>
<td></td>
</tr>
<tr>
<td>Temperatur error</td>
<td>$E_T$</td>
<td></td>
<td>±2.0</td>
<td>±3.0</td>
<td>K</td>
<td></td>
</tr>
</tbody>
</table>

### Configuration, digital interface

<table>
<thead>
<tr>
<th>Parameter</th>
<th></th>
<th></th>
</tr>
</thead>
<tbody>
<tr>
<td>System clock frequency</td>
<td>$^{13}$</td>
<td>4 MHz</td>
</tr>
<tr>
<td>Update period</td>
<td>$^{13}$</td>
<td>0.5 ms</td>
</tr>
<tr>
<td>Communication type</td>
<td>$^{13}$</td>
<td>SPI</td>
</tr>
<tr>
<td>Sensor connection check</td>
<td>$^{13}$</td>
<td>inactive</td>
</tr>
<tr>
<td>Sensor short check</td>
<td>$^{13}$</td>
<td>inactive</td>
</tr>
<tr>
<td>I²C-adress</td>
<td>$^{13}$</td>
<td>0 x 10</td>
</tr>
</tbody>
</table>
### Anti-aliasing filter

<table>
<thead>
<tr>
<th>Attenuation reference</th>
<th>3Hz</th>
<th>0 dB</th>
</tr>
</thead>
<tbody>
<tr>
<td>Attenuation</td>
<td>30Hz</td>
<td>8±1.5 dB</td>
</tr>
<tr>
<td>Attenuation</td>
<td>200Hz</td>
<td>32±8 dB</td>
</tr>
</tbody>
</table>

### Characteristics

![Simple output and Connection diagram](image)

**Materials in contact to the measured media**

- Gloptop material based on epoxy
- Silicone adhesive
- Silicone gel
- Glass
- Silicon
- Aluminium
- Nickel
- ENIG surface on pcb
Symbols and terms

1) Storage temperature range $T_{st}$
   A storage of the pressure sensor within the temperature range $T_{st,min}$ up to $T_{st,max}$ and without applied pressure and supply voltage will not affect the performance of the pressure sensor.

2) Operating temperature range $T_{a}$
   An operation of the pressure sensor within the temperature range $T_{a,min}$ up to $T_{a,max}$ will not affect the performance of the pressure sensor.

3) Compensated temperature range $T_{c}$
   While operating the pressure sensor within the temperature range $T_{c,min}$ up to $T_{c,max}$, the deviation of the output signal from the values at 25 °C will not exceed the temperature coefficients. Out of the compensated temperature range, the deviations may increase.

4) Rated pressure $p_r$
   Within the rated pressure range $p_{r,min}$ up to $p_{r,max}$, the signal output characteristic corresponds to this specification.

5) Over pressure $p_{OV}$
   Pressure cycles within the pressure range 0 up to $p_{OV}$ will not affect the performance of the pressure sensor.

6) Supply voltage $V_{CC}$
   $V_{CC,max}$ is the maximum permissible supply voltage, which can be applied without damages. $V_{CC,min}$ is the minimum required supply voltage, which has to be applied for normal operation.

7) Offset $D_{A0}$
   The offset $D_{A0}$ is the signal output $D_A(p = 0)$.

8) Signal span (Full Scale)
   $DFS = FS = DA(p_{r,max}) - DA(p_{r,min})$

9) Offset error $E_{OLTS}$
   Sum of temperature hysteresis and all non systematic offset changes. The temperature hysteresis is the change of offset, starting from the value at 25 °C after a temperature change and return to 25 °C. Determined during temperature cycles in operating temperature range (cycles with 1 K/min).

10) Non-linearity $L$ (including pressure hysteresis)
    The non-linearity is the deviation of the real sensor characteristic $ICC = f(p)$ from the ideal straight line. It can be approximated by a polynomial of second order, with the maximum at $p_x = p_r / 2$.
    The equation to calculate the non-linearity is:

11) Characteristic curve error $E_C$
    Within the compensated temperature range $T_{c,min}$ up to $T_{c,max}$ the error of characteristic curve $E_C$ is the maximum deviation to the ideal characteristic curve, including non-linearity, calibration tolerances as well as temperature errors of offset and span. Out of the compensated temperature range, the deviations may increase.

12) Total error $E_{Total} = E_{OLTS} + E_C$
    Sum of Offset error and characteristic curve error. The offset error $E_{OLTS}$ is a parallel translation of the whole tolerance zone of the characteristic curve error. A periodic (to be defined by the user) offset correction at a defined pressure (e.g. zero) may considerably improve the measurement accuracy.

13) Functional description
    For detailed description of the SPI digital interface see the data sheet “ZSC31014_iLite_datasheet_rev1.51”. (Provided by ZMDi)

IF) Significant characteristic
    Internal function relevant significant characteristic
Cautions and warnings

Storage
The pressure sensors should be stored in their original packaging. They should not be placed in harmful environments such as corrosive gases nor exposed to heat or direct sunlight, which may cause deformations. Similar effects may result from extreme storage temperatures and climatic conditions. Avoid storing the pressure sensors in an environment where condensation may form or in a location exposed to corrosive gases, which will adversely affect their performance.

Soldering
The thermal capacity of the pressure sensor is normally low, so measurements should be taken to minimize the effects of external heat. High temperatures may lead to damage or changes in characteristics. A no-clean flux should normally be used. Flux removal processes are not recommended. Avoid rapid cooling due to dipping in solvent. Note that the output signal may change if pressure is applied to the terminals during soldering.

Operation
Media compatibility with the pressure sensors must be ensured to prevent their failure (see page 2). The use of inappropriate media can cause damage and malfunction. Never use them in atmospheres containing explosive liquids or gases. Ensure pressure equalization to the environment, if relative pressure sensors are used. Avoid operating the pressure sensors in an environment where condensation may form or in a location exposed to corrosive gases. These environments adversely affect performance of the sensors. If the operating pressure is not within the rated pressure range, it may change the output characteristics. Do not exceed the rated overpressure, it may damage the pressure sensor. Do not exceed the maximum rated supply voltage, it may damage the pressure sensor. Do not exceed the rated storage temperature range, it may damage the pressure sensor. Temperature variations in both the ambient conditions and the media (liquid or gas) can affect the accuracy of the output signal from the pressure sensors. Check the operating temperature range and thermal error specification of the pressure sensors to determine their suitability for the application. Connections must be wired in accordance with the terminal assignment specified in this publication. Care should be taken as reversed pin connections can damage the pressure sensors or degrade their performance. Contact between the pressure sensor terminals and metals or other materials may cause errors in the output characteristics.

This listing does not claim to be complete, but merely reflects the experience of TDK Sensors AG & Co. KG.

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